74LVC74ADual D-type flip-flop with set and reset; positive-edge triggerRev. 7 - 20 November 2012Product data sheet

## 1. General description

The 74LVC74A is a dual edge triggered D-type flip-flop with individual data (nD) inputs, clock (nCP) inputs, set (nSD) and (nRD) inputs, and complementary nQ and nQ outputs.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the nQ output on the LOW-to-HIGH transition of the clock pulse. The nD inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition, for predictable operation.

Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

## 2. Features and benefits

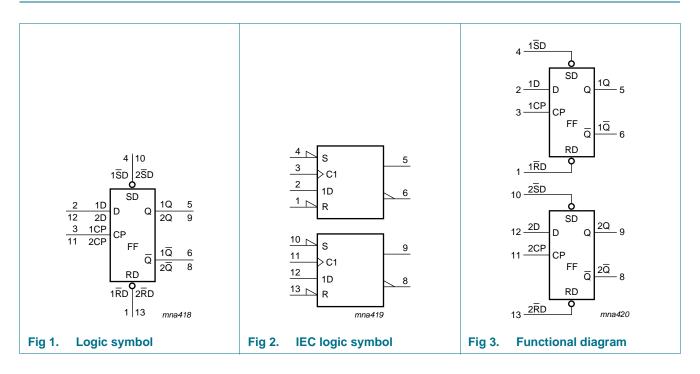
- 5 V tolerant inputs for interlacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C



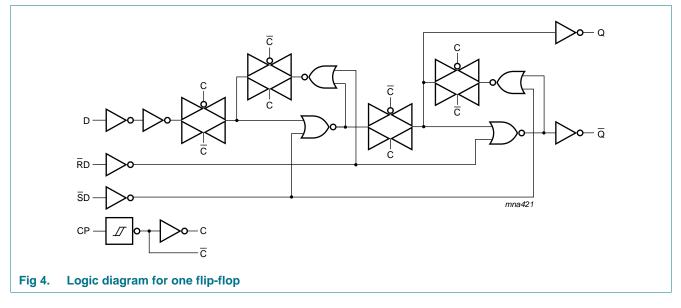
## 3. Ordering information

Table 1. Ord	lering information			
Type number	Package			
	Temperature range	Name	Description	Version
74LVC74AD	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LVC74ADB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1
74LVC74APW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC74ABQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1

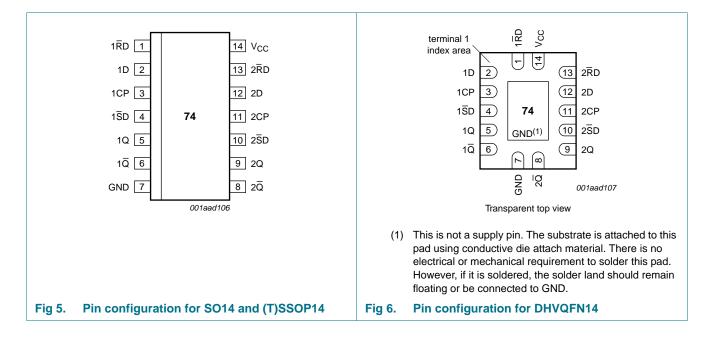
# 4. Functional diagram



#### Dual D-type flip-flop with set and reset; positive-edge trigger



## 5. Pinning information



#### 5.1 Pinning

## 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1RD	1	asynchronous reset-direct input (active LOW)
1D	2	data input
1CP	3	clock input (LOW-to-HIGH, edge-triggered)
1 <mark>S</mark> D	4	asynchronous set-direct input (active LOW)
1Q	5	true output
1 <mark>Q</mark>	6	complement output
GND	7	ground (0 V)
2 <mark>Q</mark>	8	complement output
2Q	9	true output
2 <mark>S</mark> D	10	asynchronous set-direct input (active LOW)
2CP	11	clock input (LOW-to-HIGH, edge-triggered)
2D	12	data input
2RD	13	asynchronous reset-direct input (active LOW)
V <sub>CC</sub>	14	supply voltage

# 6. Functional description

#### Table 3. Function table<sup>[1]</sup>

Input				Output	
n <mark>S</mark> D	nRD	nCP	nD	nQ	nQ
L	Н	Х	Х	Н	L
Н	L	Х	Х	L	Н
L	L	Х	Х	Н	Н

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

#### Table 4. Function table<sup>[1]</sup>

Input				Output	
nSD	nRD	nCP	nD	nQ <sub>n+1</sub>	nQ <sub>n+1</sub>
Н	Н	^	L	L	Н
Н	Н	↑	Н	Н	L

[1] H = HIGH voltage level

L = LOW voltage level

 $\uparrow$  = LOW-to-HIGH transition

 $Q_{n+1}$  = state after the next LOW-to-HIGH CP transition

X = don't care

Dual D-type flip-flop with set and reset; positive-edge trigger

# 7. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			•		,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage		[2] -0.5	$V_{CC} + 0.5$	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO14 packages: above 70 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.
 For (T)SSOP14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.
 For DHVQFN14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly with 4.5 mW/K.

## 8. Recommended operating conditions

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>CC</sub>	supply voltage	for maximum speed performance	1.65	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
	fall rate	$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

# 9. Static characteristics

#### Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Мах	Min	Max		
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V	
	input voltage	$V_{CC} = 1.65 \text{ V}$ to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V	
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V	
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V	
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	
V <sub>он</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V	
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V	
		$I_0$ = 8 mA; $V_{CC}$ = 2.3 V	-	-	0.6	-	0.8	V	
		$I_0$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V	
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
I	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA	
lcc	supply current	$\label{eq:VCC} \begin{array}{l} V_{CC} = 3.6 \ \text{V}; \ \text{V}_{\text{I}} = \text{V}_{CC} \ \text{or GND}; \\ I_{O} = 0 \ \text{A} \end{array}$	-	0.1	10	-	40	μA	
∆l <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ	
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>	-	4.0	-	-	-	pF	

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## **10.** Dynamic characteristics

#### Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation	nCP to nQ, n $\overline{Q}$ ; see Figure 7	1					
	delay	$V_{CC} = 1.2 V$	-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	1.0	5.0	10.3	1.0	11.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.8	2.9	5.8	1.8	6.7	ns
		$V_{CC} = 2.7 V$	1.0	2.7	6.0	1.0	7.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.6	5.2	1.0	6.5	ns
		nSD to nQ, nQ; see Figure 8						
		$V_{CC} = 1.2 V$	-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.5	4.0	10.6	0.5	12.2	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.0	2.4	6.1	1.0	7.1	ns
		$V_{CC} = 2.7 V$	1.0	2.9	6.4	1.0	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.2	5.4	1.0	7.0	ns
		nRD to nQ, nQ; see Figure 8						
		$V_{CC} = 1.2 V$	-	15	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.5	4.1	10.7	0.5	12.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.0	2.4	6.1	1.0	7.1	ns
		$V_{CC} = 2.7 V$	1.0	3.0	6.4	1.0	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.2	5.4	1.0	7.0	ns
t <sub>W</sub>	pulse width	clock HIGH or LOW; see Figure 7						
		$V_{CC}$ = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$	3.3	-	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	3.3	1.3	-	4.5	-	ns
		set or reset LOW; see Figure 8						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	5.0	-	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$	3.3	-	-	4.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	3.3	1.7	-	4.5	-	ns
t <sub>rec</sub>	recovery time	set or reset; see Figure 8						
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	1.5	-	-	1.5	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.5	-	-	1.5	-	ns
		$V_{CC} = 2.7 V$	1.5	-	-	1.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V	+1.0	-3.0	-	1.0	-	ns

7 of 19

# 74LVC74A

#### Dual D-type flip-flop with set and reset; positive-edge trigger

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>su</sub>	set-up time	nD to nCP; see Figure 7						1	
		$V_{CC}$ = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.2	-	-	2.2	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	0.8	-	2.0	-	ns
t <sub>h</sub>	hold time	nD to nCP; see Figure 7							
		$V_{CC}$ = 1.65 V to 1.95 V		2.0	-	-	2.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	-	-	1.5	-	ns
		$V_{CC} = 2.7 V$		1.0	-	-	1.0	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		+1.0	-0.2	-	1.0	-	ns
f <sub>max</sub>	maximum	nCP; see <u>Figure 7</u>							
	frequency	$V_{CC}$ = 1.65 V to 1.95 V		100	-	-	80	-	MHz
		$V_{CC}$ = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	250	-	120	-	MHz
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power	per flip-flop; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
	dissipation	$V_{CC}$ = 1.65 V to 1.95 V		-	12.4	-	-	-	pF
	capacitance	$V_{CC}$ = 2.3 V to 2.7 V		-	16.0	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	19.1	-	-	-	pF

#### Table 8. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 9</u>.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

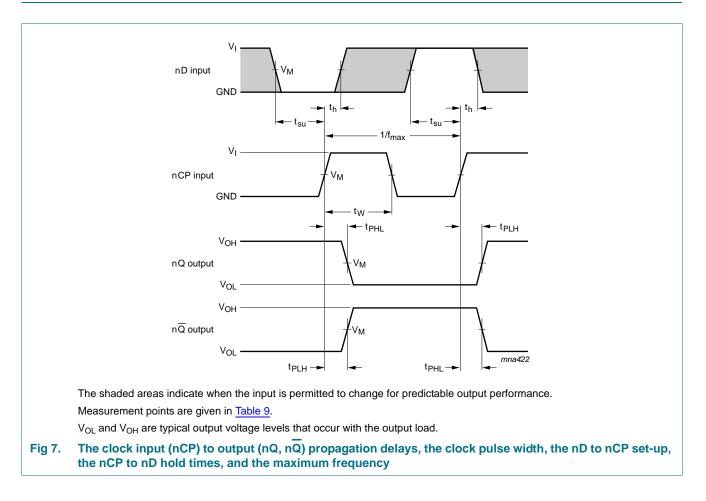
V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs

#### Dual D-type flip-flop with set and reset; positive-edge trigger

# 11. AC waveforms



# 74LVC74A

Dual D-type flip-flop with set and reset; positive-edge trigger

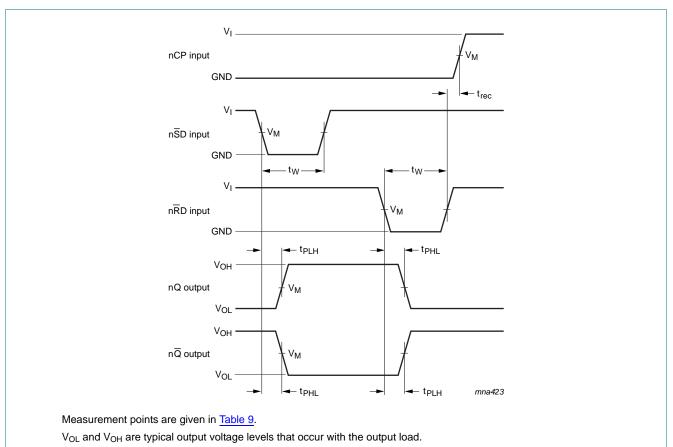


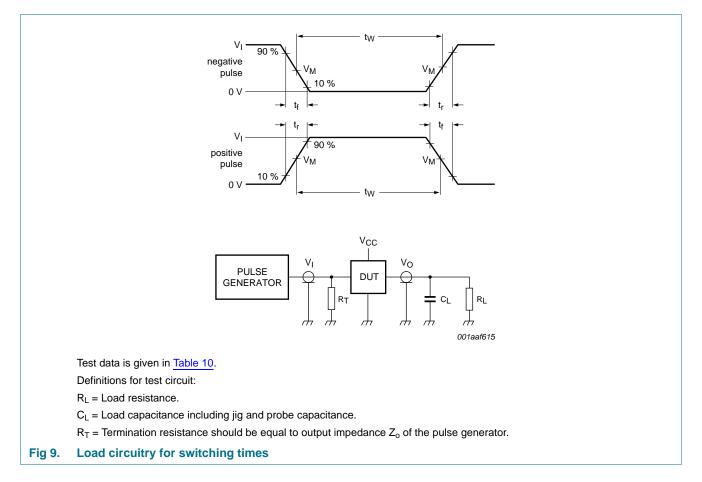
Fig 8. The set (nSD) and reset (nRD) input to output (nQ, nQ) propagation delays, the set and reset pulse widths, and the nRD to nCP recovery time

#### Table 9. Measurement points

Supply voltage	Input		Output	
V <sub>cc</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	
1.2 V	V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$	
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$	
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$	
2.7 V	2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	

# 74LVC74A

#### Dual D-type flip-flop with set and reset; positive-edge trigger



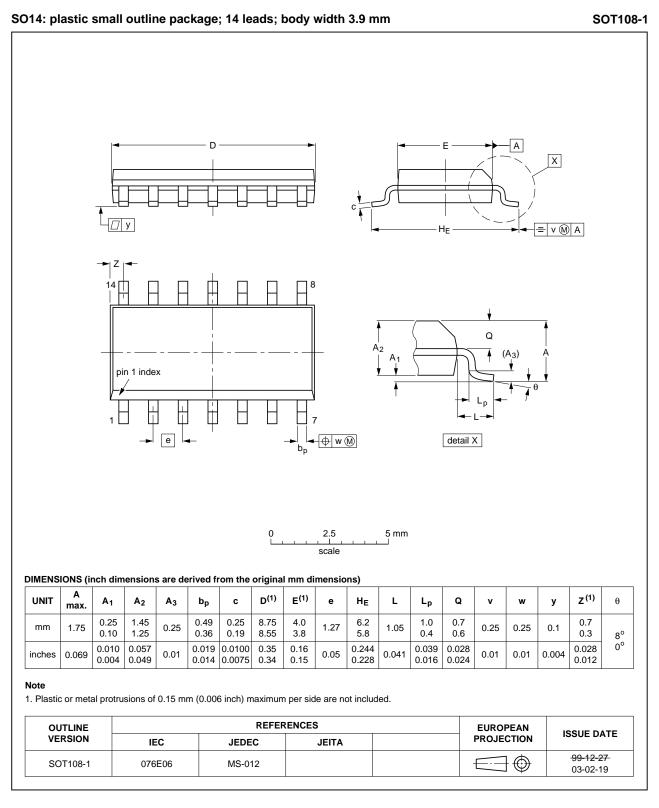
#### Table 10. Test data

Supply voltage	Input		Load	Load		V <sub>EXT</sub>		
V <sub>cc</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

# 74LVC74A

Dual D-type flip-flop with set and reset; positive-edge trigger

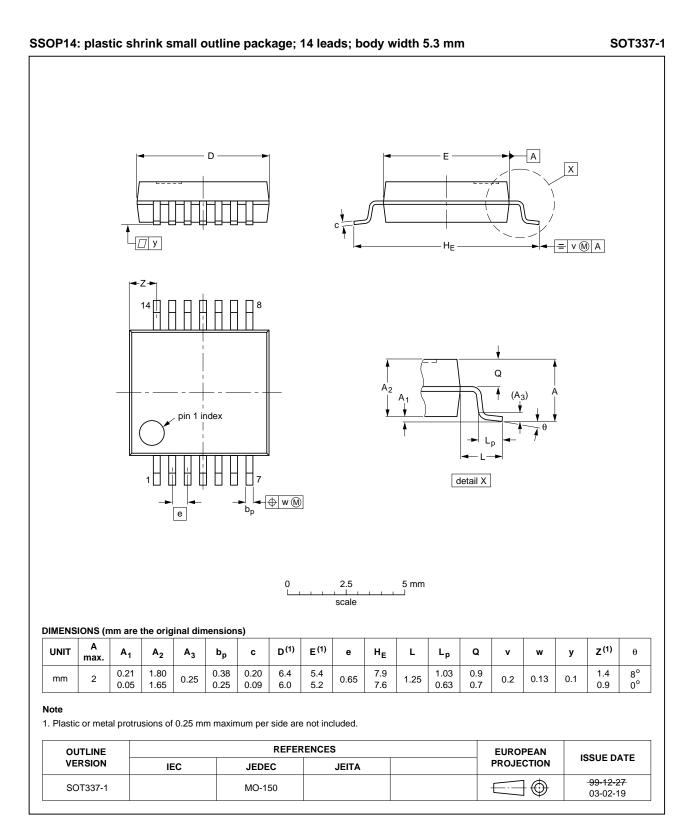
## 12. Package outline



#### Fig 10. Package outline SOT108-1 (SO14)

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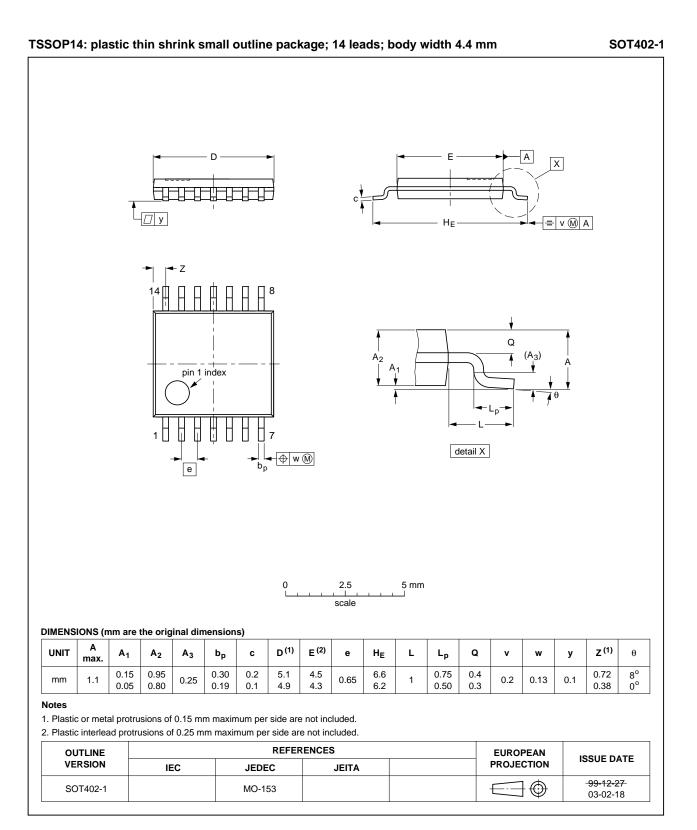
Dual D-type flip-flop with set and reset; positive-edge trigger



#### Fig 11. Package outline SOT337-1 (SSOP14)

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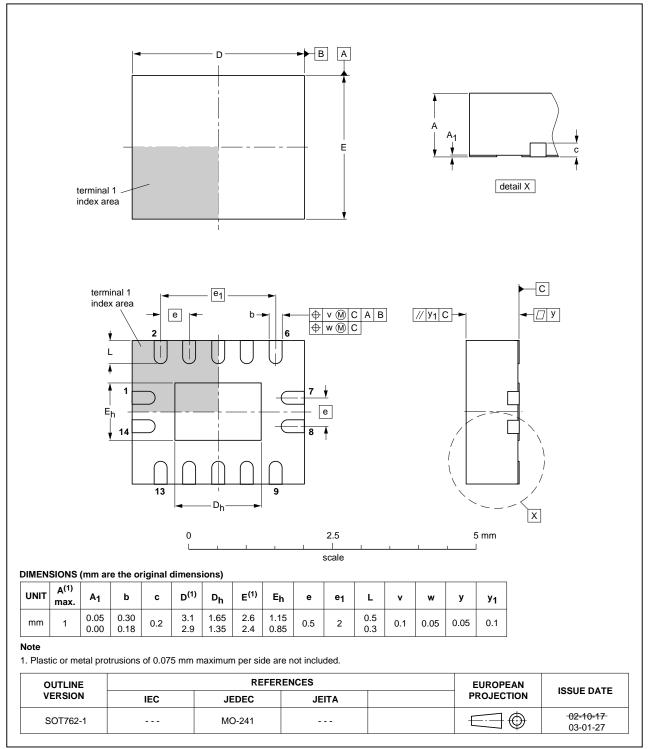
Dual D-type flip-flop with set and reset; positive-edge trigger



#### Fig 12. Package outline SOT402-1 (TSSOP14)

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Dual D-type flip-flop with set and reset; positive-edge trigger



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

#### Fig 13. Package outline SOT762-1 (DHVQFN14)

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# 13. Abbreviations

Table 11. Abbi	eviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

Table 12. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC74A v.7	20121120	Product data sheet	-	74LVC74A v.6	
Modifications:	• <u>Table 6, Table 7, T</u>	able 8, <u>Table 9</u> and <u>Table</u>	10: values added for low	er voltage ranges.	
74LVC74A v.6	20070604	Product data sheet	-	74LVC74A v.5	
74LVC74A v.5	20070525	Product data sheet	-	74LVC74A v.4	
74LVC74A v.4	20030526	Product specification	-	74LVC74A v.3	
74LVC74A v.3	20020618	Product specification	-	74LVC74A v.2	
74LVC74A v.2	19980617	Product specification	-	74LVC74A v.1	
74LVC74A v.1	19980617	Product specification	-	-	

## **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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# 74LVC74A

Dual D-type flip-flop with set and reset; positive-edge trigger

## **17. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning 3
5.2	Pin description 4
6	Functional description 4
7	Limiting values 5
8	Recommended operating conditions 5
9	Static characteristics 6
10	Dynamic characteristics 7
11	AC waveforms 9
12	Package outline 12
13	Abbreviations 16
14	Revision history 16
15	Legal information 17
15.1	Data sheet status 17
15.2	Definitions 17
15.3	Disclaimers 17
15.4	Trademarks
16	Contact information 18
17	Contents 19

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